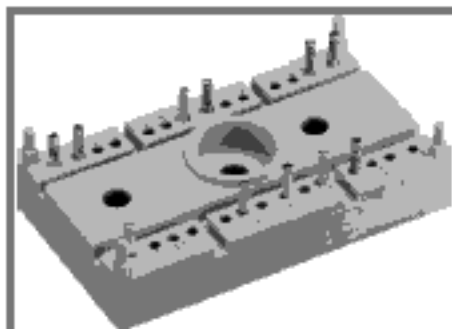


# SK 70 DH



SEMITOP® 3

## Half Controlled Bridge Rectifier

SK 70 DH

Preliminary Data

### Features

- Compact design
- One screw mounting
- Heat transfer and insulation through direct copper bonded aluminium oxide ceramic (DBC)
- Glass passivated thyristor chips
- Up to 1600V reverse voltage
- UL recognized, file no. E 63 532

### Typical Applications

- Soft starters
- Light control
- Temperature control
- Motor control

$V_{RSM}$ V	$V_{RRM}, V_{DRM}$ V	$I_D = 68$ A (full conduction) ( $T_s = 80$ °C)
900	800	SK 70 DH 08
1300	1200	SK 70 DH 12
1700	1600	SK 70 DH 16

Symbol	Conditions	Values	Units
$I_D$	$T_s = 80$ °C	68	A
$I_{FSM} / I_{TSM}$	$T_{vj} = 25$ °C; 10 ms	370	A
$P_t$	$T_{vj} = 125$ °C; 10 ms	280	A
	$T_{vj} = 25$ °C; 8,3 ... 10 ms	686	A <sup>2</sup> s
	$T_{vj} = 125$ °C; 8,3...10 ms	366	A <sup>2</sup> s
	$T_{vj} = 25$ °C; 76A	max. 1,9	V
$V_{T(RO)}$	$T_{vj} = 125$ °C;	1	V
$r_T$	$T_{vj} = 125$ °C	10	mΩ
$I_{DD}, I_{RD}$	$T_{vj} = 125$ °C; $V_{DD} = V_{DRM}; V_{RD} = V_{RRM}$	max. 10	mA
$t_{gd}$	$T_{vj} = 25$ °C; $I_G = 1$ A; $di_G/dt = 1$ A/μs	1	μs
$t_{gr}$	$V_D = 0,67 \cdot V_{DRM}$	2	μs
$(dv/dt)_cr$	$T_{vj} = 125$ °C; d.c.	max. 1000	V/μs
$(di/dt)_cr$	$T_{vj} = 125$ °C; d.c.; $f = 60...60$ Hz	max. 60	A/μs
$t_q$	$T_{vj} = 125$ °C; d.c.; $t_{fp}$ .	120	μs
$I_H$	$T_{vj} = 25$ °C; d.c.; $t_{fp} / \text{max.}$	80 / 150	mA
$I_L$	$T_{vj} = 25$ °C; d.c.; $R_G = 33$ Ω	160 / 300	mA
$V_{GT}$	$T_{vj} = 25$ °C; d.c.	min. 2	V
$I_{GT}$	$T_{vj} = 25$ °C; d.c.	min. 100	mA
$V_{GD}$	$T_{vj} = 125$ °C; d.c.	max. 0,25	V
$I_{GD}$	$T_{vj} = 125$ °C; d.c.	max. 3	mA
$R_{th(j-s)}$	Per thyristor	1,2	K/W
	Per diode	1,7	K/W
$T_{solder}$	Terminals, 10s	260	°C
$T_{vj}$	Diodes	-40...+160	°C
$T_{vj}$			°C
$T_{vj}$			°C
$T_{vj}$	Thyristors	-40...+125	°C
$T_{vj}$		-40...+125	°C
$V_{isol}$	a. c. 60 Hz; r.m.s.; 1 s / 1 min.	3000 ( 2600 )	V
$M_s$	Mounting torque to heatsink	2,6	Nm
$\alpha$			m/s <sup>2</sup>
$m$	weight	30	g
Case	SEMITOP® 3	T 40	

DH

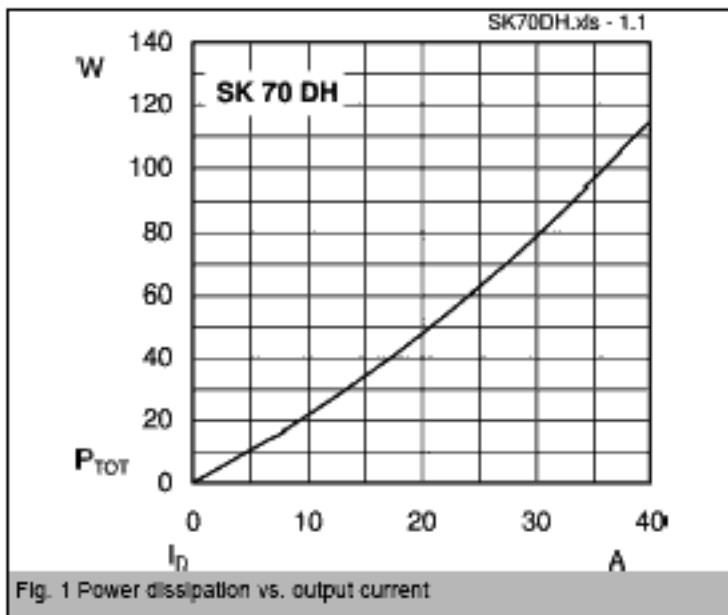


Fig. 1 Power dissipation vs. output current

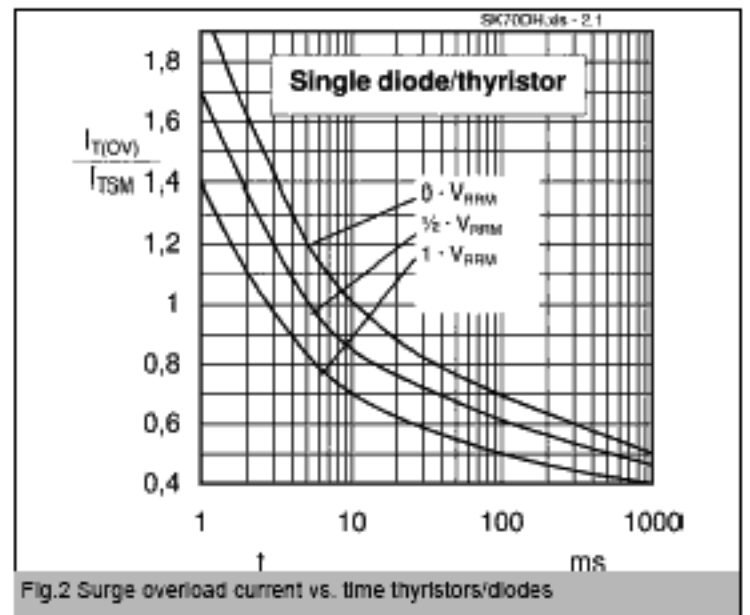


Fig. 2 Surge overload current vs. time thyristors/diodes

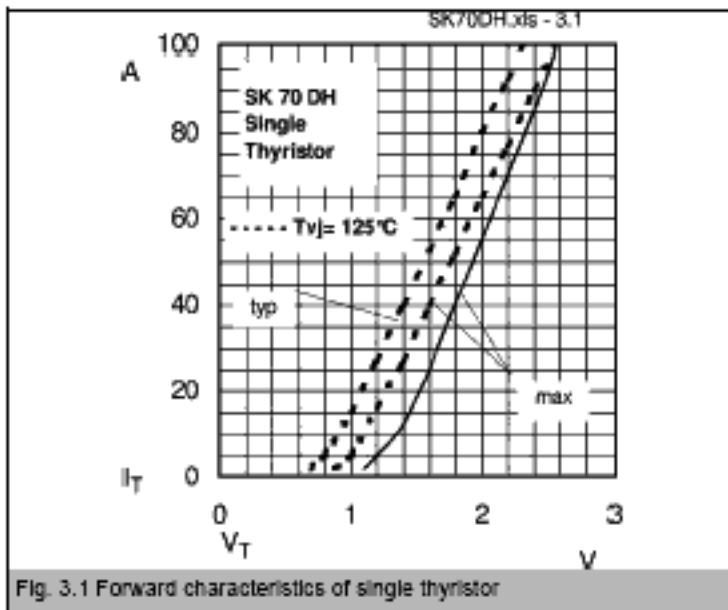


Fig. 3.1 Forward characteristics of single thyristor

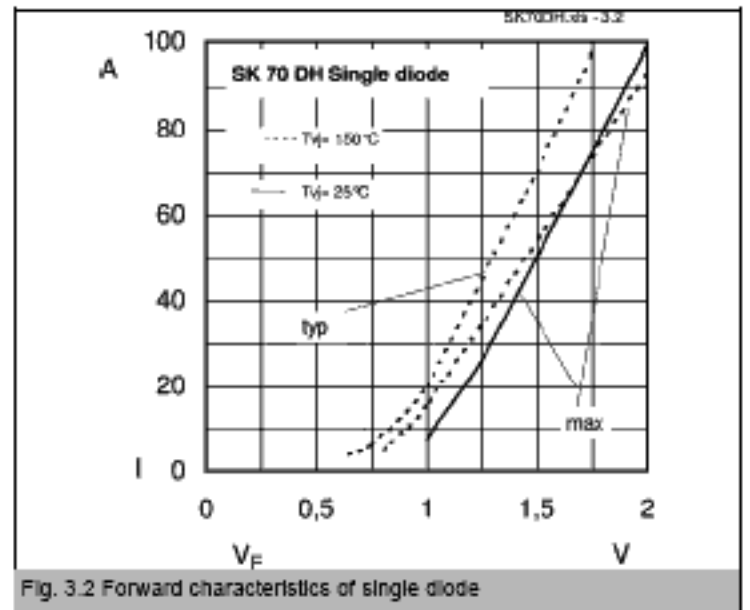


Fig. 3.2 Forward characteristics of single diode

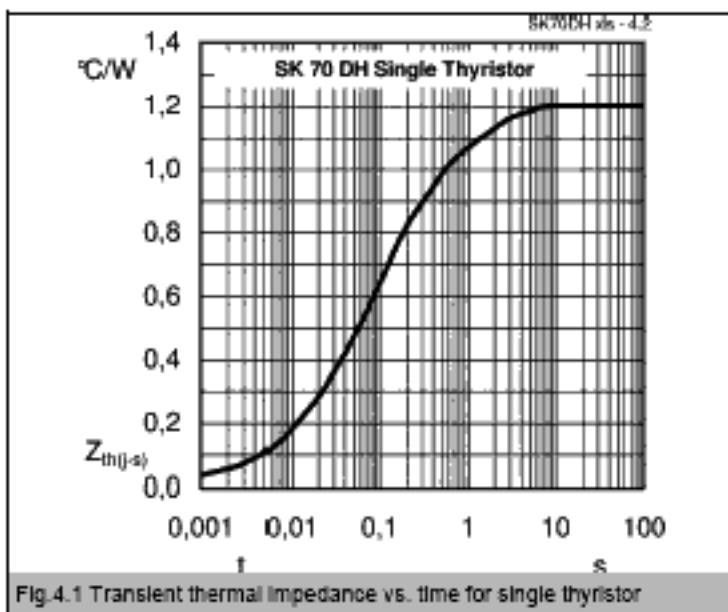


Fig. 4.1 Transient thermal impedance vs. time for single thyristor

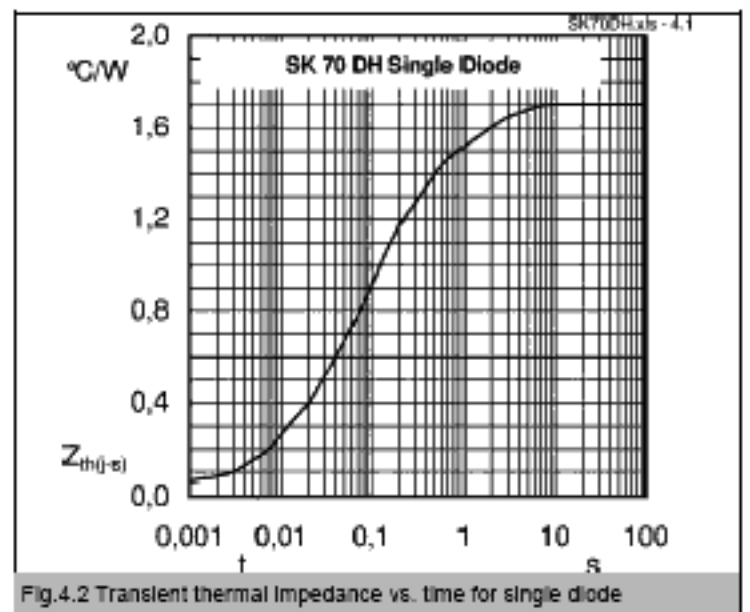


Fig. 4.2 Transient thermal impedance vs. time for single diode

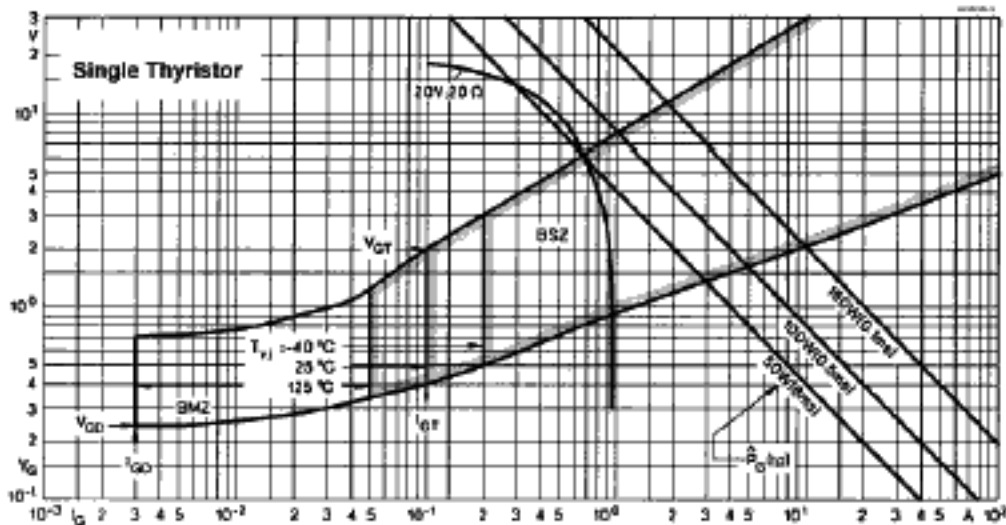
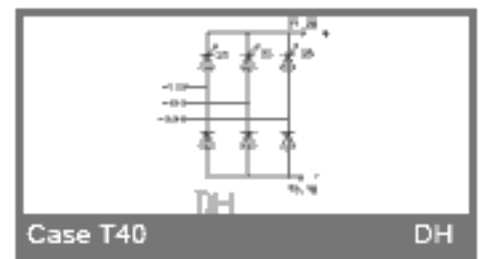
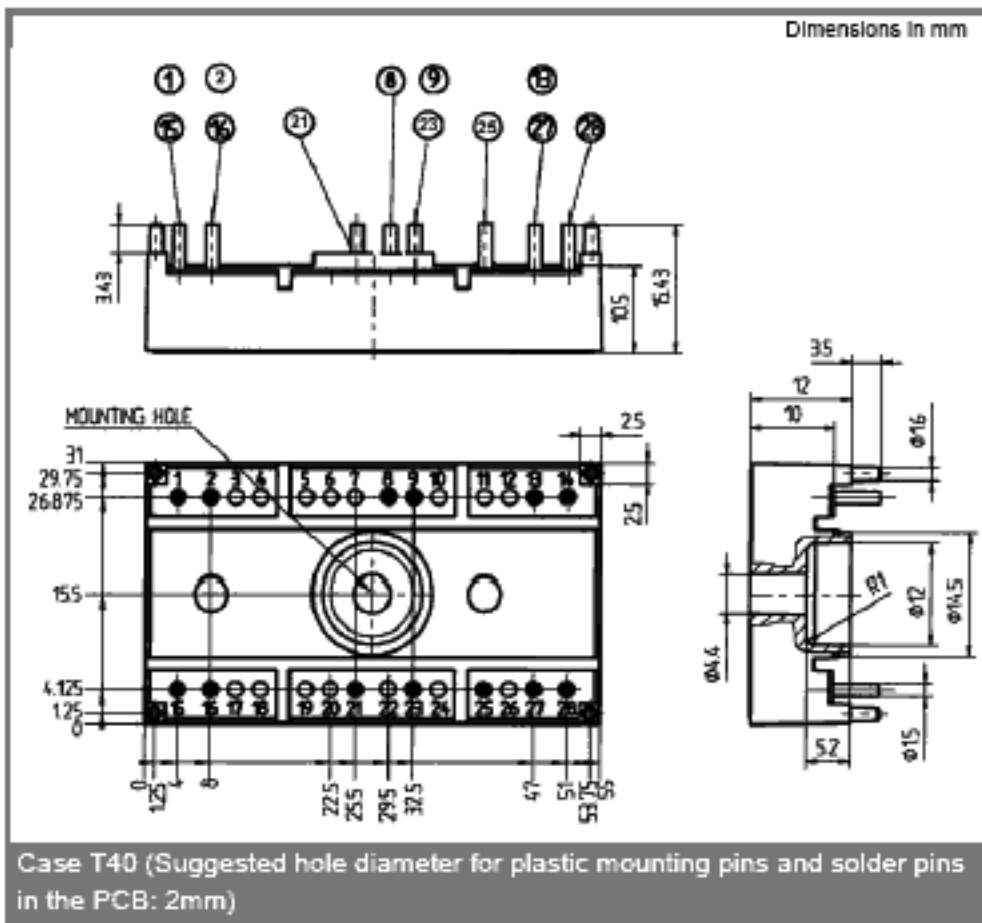


Fig. 5 Gate trigger characteristics



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